
MARKING:
SOD-123
特征 Features
SOD-123 贴片塑封二极管

- 开关速度小于 4.0nS; Fast Switching Device (TRR <4.0 nS)
- 最大功率耗散 500mW; Power Dissipation of 500mW
- 高稳定性和可靠性。High Stability and High Reliability
- 反向漏电流小。Low reverse leakage

机械数据 Mechanical Data

- 封装: SOD-123 封装 SOD-123 Small Outline Plastic Package
- 极性: 色环端为负极Polarity: Color band denotes cathode end
- 环氧树脂UL 易燃等级Epoxy UL: 94V-0
- 安装位置: 任意 Mounting Position: Any

极限值和温度特性($T_A = 25^\circ\text{C}$ 除非另有规定)

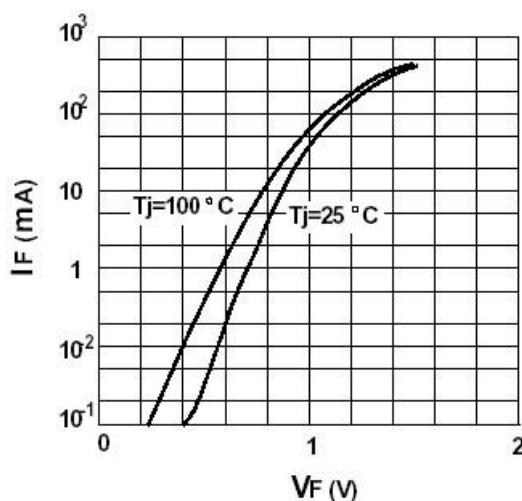
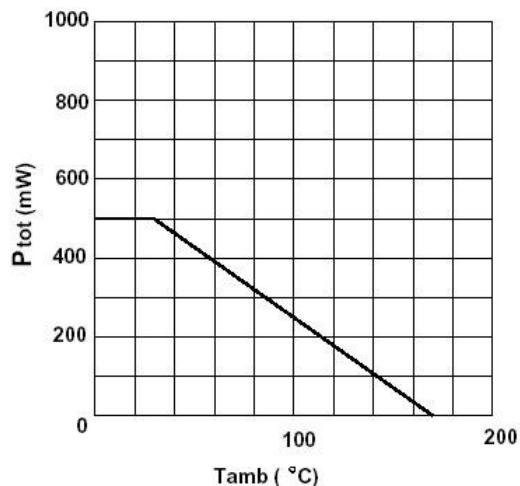
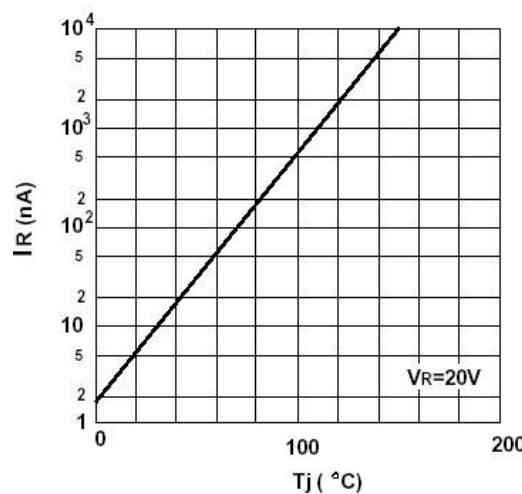
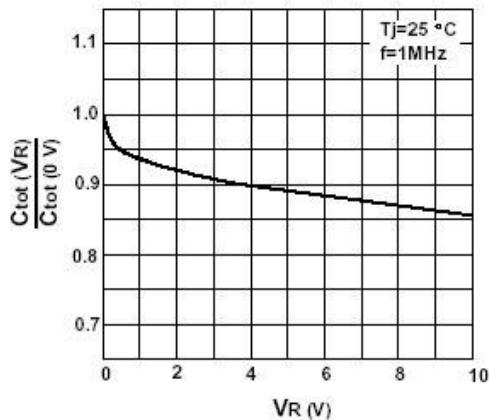
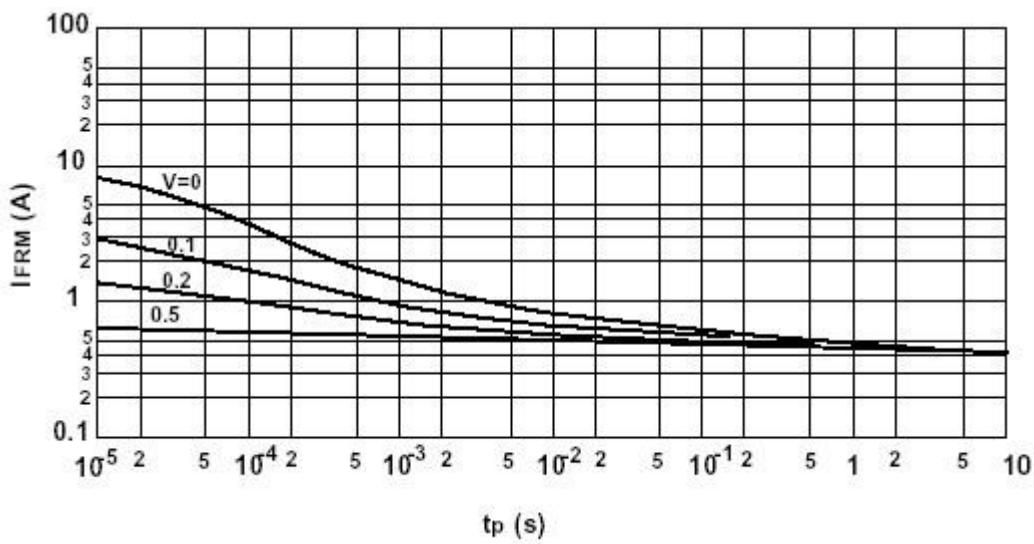
Maximum Ratings & Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified.)

参数 Parameters	符号 Symbol	数值 Value	单位 Unit
反向峰值电压 Peak Reverse Voltage	V_{RM}	100	V
功率消耗 Power Dissipation	P_d	500	mW
工作结温 Operating junction temperature	T_j	150	°C
存储温度 Storage temperature range	T_{STG}	-65~+150	°C
热阻 Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	250	°C/W
平均整流电流 Average Rectified Current	I_o	150	mA
正向(不重复)电流 Non-repetitive Peak Forward Current	I_{FM}	300	mA
正向(不重复)浪涌电流 Peak Forward Surge Current @ $t_p=1\mu\text{s}; TA=25^\circ\text{C}$	I_{FSM}	2.0	A

Valid provided that electrodes are kept at ambient temperature.

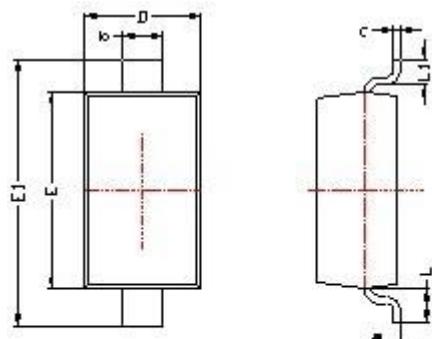
电特性 Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

符号 Symbols	参数 Parameter	测试条件 Test Condition	界限 Limits		单位 Unit
			Min	Max	
B_v	反向击穿电压 Breakdown Voltage	$IR=100\mu\text{A}$	100		V
I_R	反向漏电电流 Reverse Leakage Current	$VR=20\text{V}$	---	25	nA
		$VR=20\text{V} T_j=150^\circ\text{C}$	---	50	μA
		$VR=75$	---	5	μA
V_F	正向电压 Forward Voltage	$IF=10\text{mA}$	---	1.00	V
		$IF=100\text{mA}$	---	1.25	
TRR	反向恢复时间 Reverse Recovery Time	$IF = IR = 10\text{mA},$	---	4	nS
		$Irr=0.1XIR$			
		$RL=100\Omega$			
C	结电容 Capacitance	$VR=0\text{V}, f=1\text{MHz}$	---	4	pF

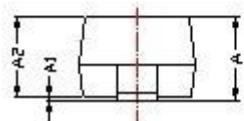
Forward characteristics

Admissible power dissipation versus ambient temperature

Leakage current versus junction temperature

Reverse capacitance VS. reverse voltge

Admissible repetitive peak forward current VS. pulse duration


SOD-123 PACKAGE OUTLINE

Plastic surface mounted package



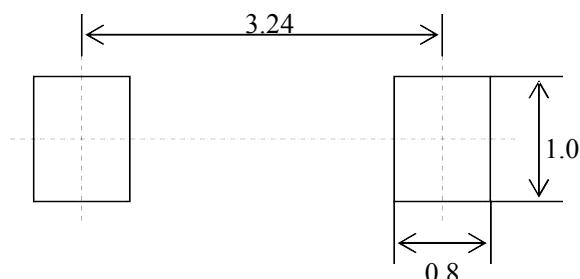
SYMBOL	DIMENSIONS	
	MIN.	MAX.
A	1.050	1.250
A1	0.000	0.100
A2	1.050	1.150
b	0.450	0.650
c	0.080	0.150
D	1.500	1.700
E	2.600	2.800
E1	3.550	3.850
L	0.500REF	
L1	0.250	0.450
B	0°	8°



焊盘设计参考

Precautions: PCB Design

Recommended land dimensions for SOD-123 diode. Electrode patterns for PCBs



技术要求:
 中心距: 3.24
 脚 宽 : 0.55
 焊盘宽: 1.00
 脚 长 : 0.50
 焊盘长: 0.80

1, 塑封体尺寸: 2.70 X 1.60
 2: 未注公差为: ±0.05
 3, 所有单位: mm